



SSC8L420GN6

N-Channel Enhancement Mode MOSFET

➤ Features

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	I _D
40V	±20V	2.5mΩ@10V	110A
		3mΩ@4V5	

➤ Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

100% UIS + ΔVDS + Rg Tested!

➤ Applications

- DC/DC Converters
- Power Supplies
- Motor Drive Control
- Synchronous Rectification

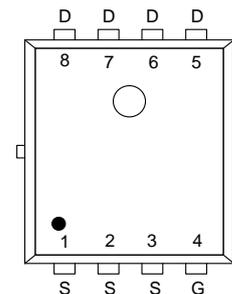
➤ Ordering Information

Device	Package	Shipping
SSC8L420GN6	PDFN5X6-8L	5000/Reel

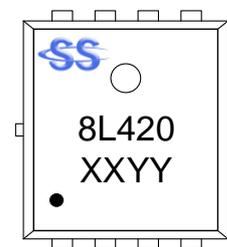
➤ Pin configuration



PDFN5X6-8L



Pin Configuration (Top View)



Marking

(XX: Product Year / YY: Product Week)



➤ Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V_{DSS}	Drain-to-Source Voltage	40	V
V_{GSS}	Gate-to-Source Voltage	± 20	V
I_D	Continuous Drain Current ^d	$T_C=25^{\circ}\text{C}$	110
		$T_C=100^{\circ}\text{C}$	55
I_{DSM}	Continuous Drain Current ^a	$T_A=25^{\circ}\text{C}$	36
		$T_A=70^{\circ}\text{C}$	25
I_{DM}	Pulsed Drain Current ^b	440	A
P_D	Power Dissipation ^c	$T_C=25^{\circ}\text{C}$	50
		$T_C=100^{\circ}\text{C}$	20
P_{DSM}	Power Dissipation ^a	$T_A=25^{\circ}\text{C}$	5.2
		$T_A=70^{\circ}\text{C}$	3.3
I_{AS}	Avalanche Current ^b $L=0.5\text{mH}$ Single Pulse	37	A
E_{AS}	Avalanche Energy ^b $L=0.5\text{mH}$ Single Pulse	342	mJ
T_J	Operation junction temperature	-55~150	$^{\circ}\text{C}$
T_{STG}	Storage temperature range	-55~150	

➤ Thermal Resistance Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance ^a	24	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Junction-to-Case Thermal Resistance	2.5	

Note:

- The value of $R_{\theta JA}$ is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with $T_A=25^{\circ}\text{C}$. The value in any given application depends on the user is specific board design. The power dissipation is based on the $t \leq 10\text{s}$ thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation P_D is based on $T_{J(\text{MAX})}=150^{\circ}\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- The maximum current rating is package limited.

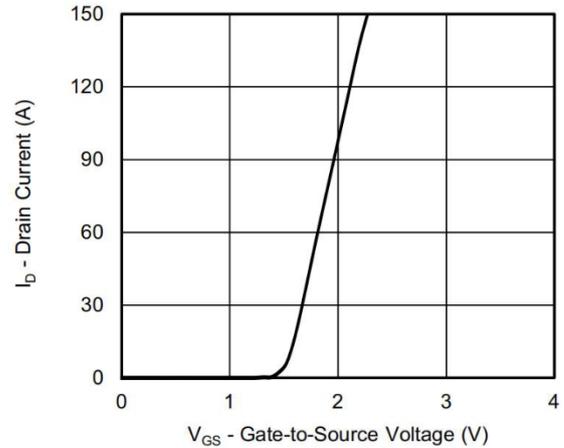
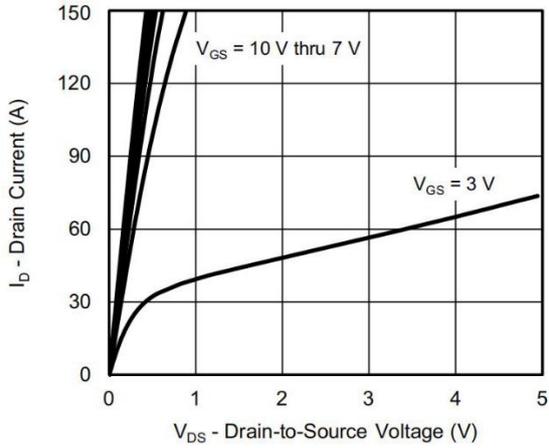


➤ **Electrical Characteristics (T_A=25°C unless otherwise noted)**

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	40			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250uA	1	1.4	2	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 20A		2.5	3.3	mΩ
		V _{GS} = 4.5V, I _D = 10A		3	4	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40V, V _{GS} = 0V			1	μA
Gate-Source Leak Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V			±150	nA
Transconductance	G _{FS}	V _{DS} = 5V, I _D = 20A		43		s
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 10A		0.73	1.3	V
Gate Resistance	R _G	V _{DS} = 0V, f = 1MHz		0.75		Ω
Input Capacitance	C _{ISS}	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz		2747		pF
Output Capacitance	C _{OSS}			680		
Reverse Transfer Capacitance	C _{RSS}			62		
Total Gate Charge	Q _G	V _{GS} = 10V, V _{DS} = 20V, I _D = 20A		57		nC
Gate to Source Charge	Q _{GS}			14		
Gate to Drain Charge	Q _{GD}			6		
Turn-on Delay Time	T _{D(ON)}	V _{GS} = 10V, V _{DS} = 20V, R _L = 1Ω, R _G = 3Ω		10		ns
Rise Time	T _r			3		
Turn-off Delay Time	T _{D(OFF)}			34		
Fall Time	T _f			2.9		
Diode Recovery Time	T _{rr}	I _F =20A, di/dt=500A/us		14		ns
Diode Recovery Charge	Q _{rr}	I _F =20A, di/dt=500A/us		43		nC

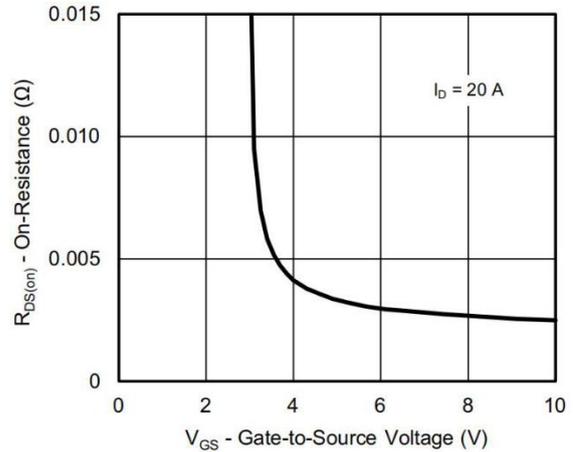
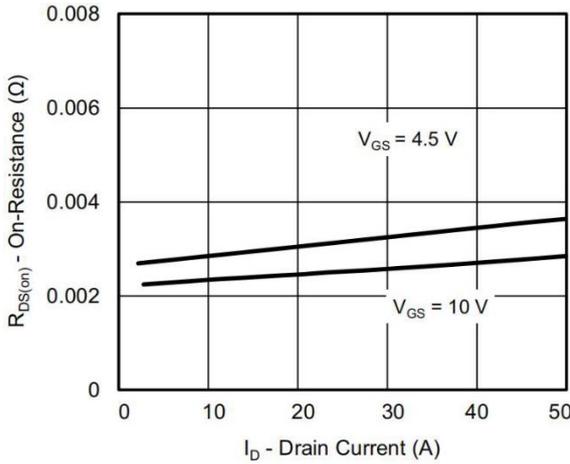


➤ **Typical Performance Characteristics (T_A=25°C unless otherwise noted)**



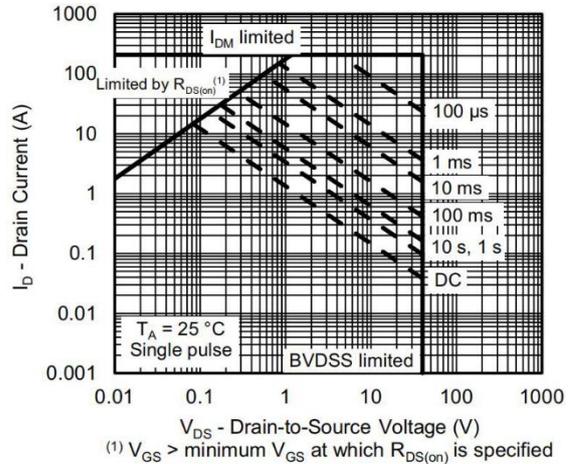
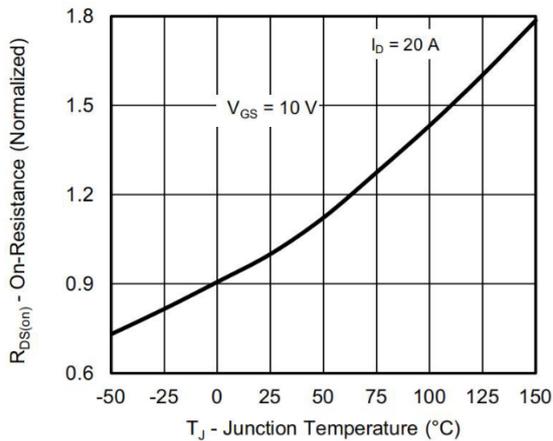
Output Characteristics

Transfer Characteristics



On-Resistance vs. Drain Current

On-Resistance vs. Gate-to-Source Voltage

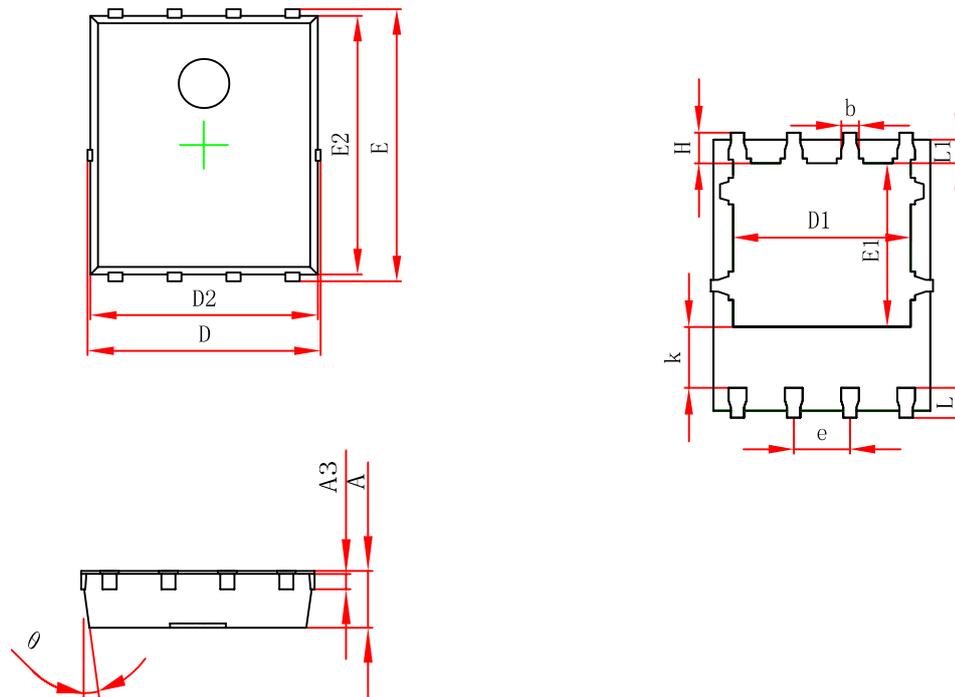


On-Resistance vs. Junction Temperature

Safe Operating Area



➤ Package Information

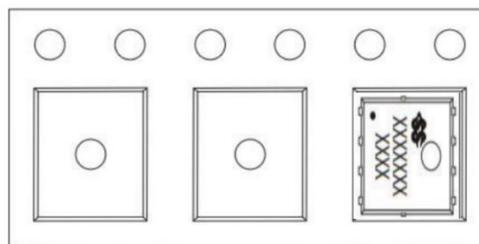
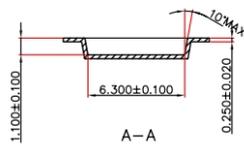
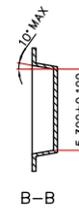
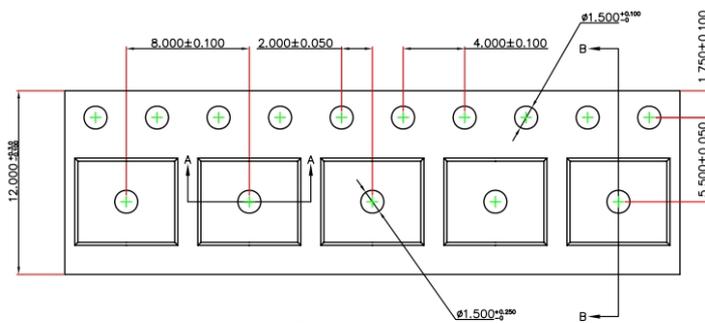
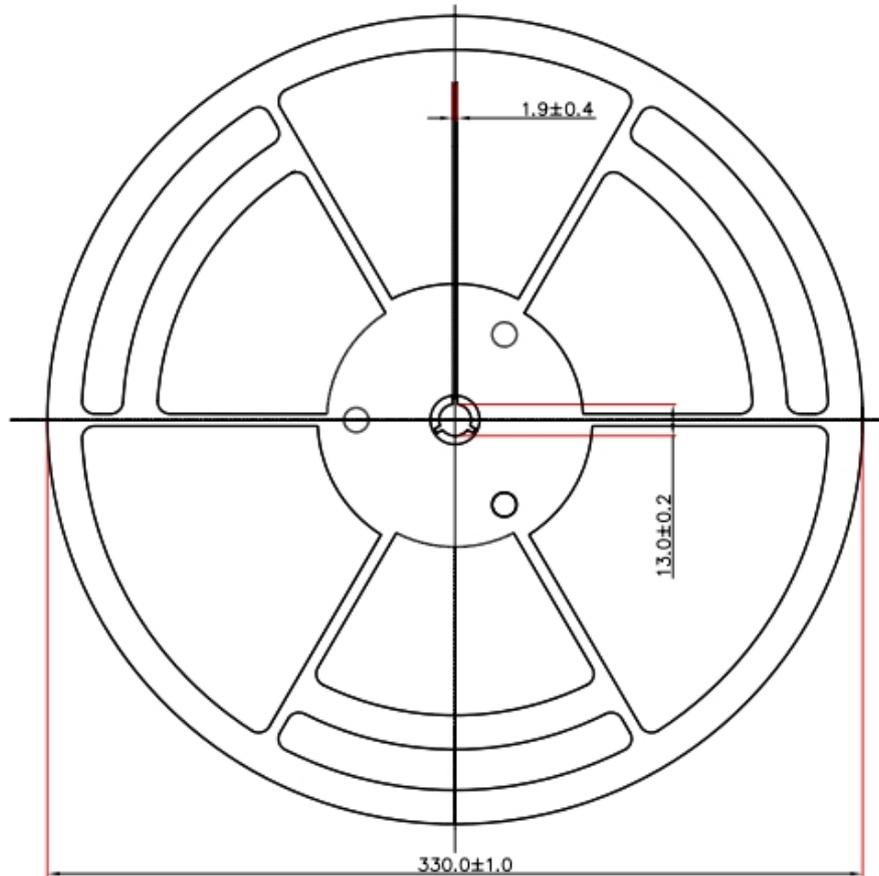


Package: PDNF5X6-8L

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°



➤ Tape and Reel





DISCLAIMER

SSCSEMI RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. SSCSEMI DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICIENCE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

THE GRAPHS PROVIDED IN THIS DOCUMENT ARE STATISTICAL SUMMARIES BASED ON A LIMITED NUMBER OF SAMPLES AND ARE PROVIDED FOR INFORMATIONAL PURPOSE ONLY. THE PERFORMANCE CHARACTERISTICS LISTED IN THEM ARE NOT TESTED OR GUARANTEED. IN SOME GRAPHS, THE DATA PRESENTED MAY BE OUTSIDE THE SPECIFIED OPERATING RANGE (E.G. OUTSIDE SPECIFIED POWER SUPPLY RANGE) AND THEREFORE OUTSIDE THE WARRANTED RANGE.

OUR PRODUCT SPECIFICATIONS ARE ONLY VALID IF OBTAINED THROUGH THE COMPANY'S OFFICIAL WEBSITE, CRM SYSTEM, OR OUR SALES PERSONNEL CHANNELS. IF CHANGES OR SPECIAL VERSIONS ARE INVOLVED, THEY MUST BE STAMPED WITH A QUALITY SEAL AND MARKED WITH A SPECIAL VERSION NUMBER TO BE VALID.